

AON6240

40V N-Channel MOSFET

General Description

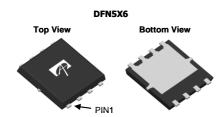
The AON6240 uses trench MOSFET technology that is uniquely optimized to provide the most efficient high frequency switching performance. Power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Crss. In addition, switching behavior is well controlled with a "Schottky style" soft recovery body diode.

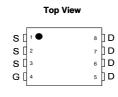
Product Summary

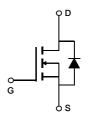
 $\begin{array}{lll} V_{DS} & 40V \\ I_{D} \; (at \; V_{GS} \! = \! 10V) & 85A \\ R_{DS(ON)} \; (at \; V_{GS} \! = \! 10V) & < 1.6 m\Omega \\ R_{DS(ON)} \; (at \; V_{GS} \! = \! 4.5V) & < 2.4 m\Omega \end{array}$

100% UIS Tested 100% R_g Tested









Absolute Maximum Ratings T _A =25℃ unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V _{DS}	40	V				
Gate-Source Voltage		V _{GS}	±20	V				
Continuous Drain	T _C =25℃		85					
Current ^G	T _C =100℃	I _D	67	A				
Pulsed Drain Current C		I _{DM}	355					
Continuous Drain	T _A =25℃		27	Δ.				
Current	T _A =70℃	IDSM	22	A				
Avalanche Current ^C		I _{AS} , I _{AR}	82	A				
Avalanche energy L=0.1mH ^C		E _{AS} , E _{AR}	336	mJ				
	T _C =25℃	P _D	83	W				
Power Dissipation ^B	T _C =100℃	FD	33	VV				
	T _A =25℃	D	2.3	W				
Power Dissipation ^A T _A =70℃		P _{DSM}	1.5					
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	C				

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	D	14	17	℃/W			
Maximum Junction-to-Ambient AD	Steady-State	$R_{\theta JA}$	40	55	℃/W			
Maximum Junction-to-Case	Steady-State	$R_{\theta JC}$	1	1.5	℃/W			



Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units				
STATIC PARAMETERS										
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	40			V				
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =40V, V _{GS} =0V			1	μA				
D33		T _J =55℃			5	μιτ				
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V			100	nA				
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=250\mu A$	1.3	1.9	2.4	V				
$I_{D(ON)}$	On state drain current	V_{GS} =10V, V_{DS} =5V	355			Α				
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A		1.3	1.6	mΩ				
		T _J =125℃		2.1	2.7	11152				
		V_{GS} =4.5V, I_{D} =20A		1.8	2.4	$m\Omega$				
g _{FS}	Forward Transconductance	$V_{DS}=5V$, $I_{D}=20A$		166		S				
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.7	1	V				
Is	Maximum Body-Diode Continuous Curr			85	Α					
DYNAMIC	PARAMETERS									
C _{iss}	Input Capacitance		4360	5458	6550	pF				
Coss	Output Capacitance	V_{GS} =0V, V_{DS} =20V, f=1MHz	970	1395	1815	pF				
C _{rss}	Reverse Transfer Capacitance	1	30	103	176	pF				
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	0.5	1.0	1.6	Ω				
SWITCHI	NG PARAMETERS									
Q _g (10V)	Total Gate Charge		58	72.8	88	nC				
Q _g (4.5V)	Total Gate Charge	V -10V V -20V I -20A	24	31	44	nC				
Q_{gs}	Gate Source Charge	V_{GS} =10V, V_{DS} =20V, I_{D} =20A		14.8		nC				
Q_{gd}	Gate Drain Charge	1		10.8		nC				
t _{D(on)}	Turn-On DelayTime			14.8		ns				
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =20V, R_L =1 Ω ,		5.5		ns				
t _{D(off)}	Turn-Off DelayTime	$R_{GEN}=3\Omega$		61.3		ns				
t _f	Turn-Off Fall Time]		10		ns				
t _{rr}	Body Diode Reverse Recovery Time	I _F =20A, dI/dt=500A/μs	16	23.9	31	ns				
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =20A, dI/dt=500A/μs	59	84.6	110	nC				

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The Power dissipation P_{DSM} is based on R $_{\theta JA}$ and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design.

- D. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to case $R_{\theta JC}$ and case to ambient.
- E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.
- F. These curves are based on the junction-to-case thermal impedence which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$ =150° C. The SOA curve provides a single pulse rating.
- G. The maximum current rating is package limited.
- H. These tests are performed with the device mounted on 1 in FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C.

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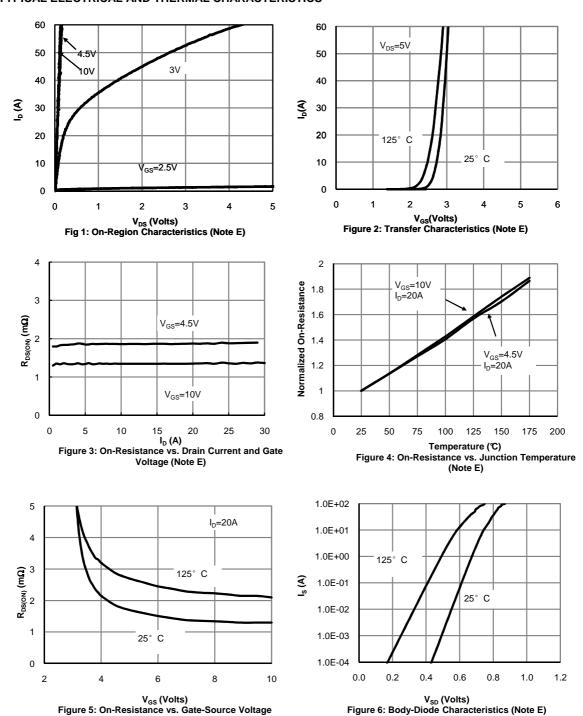
B. The power dissipation P_D is based on $T_{J(MAX)}$ =150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150° C. Ratings are based on low frequency and duty cycles to keep initial T_J =25° C.



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

(Note E)





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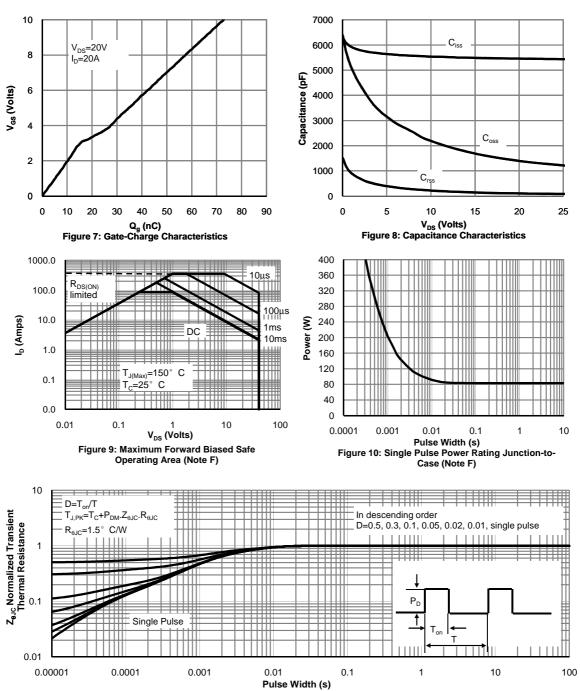
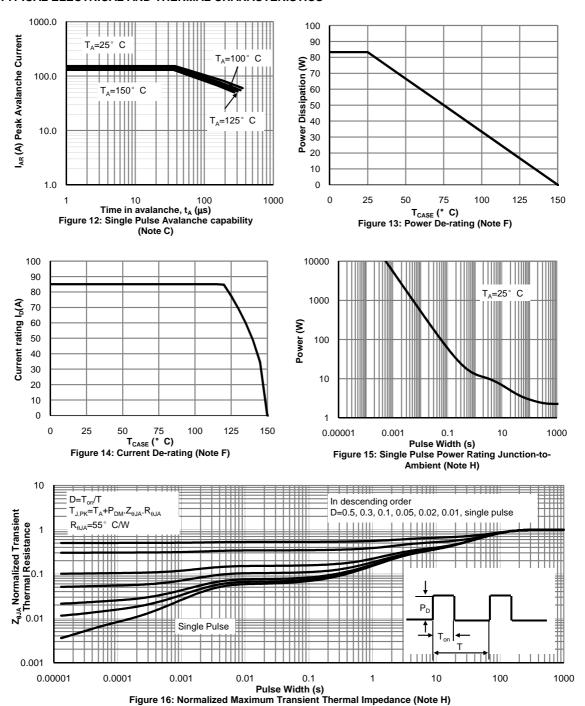


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)



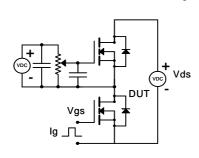
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

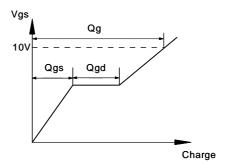


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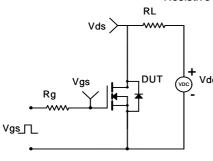


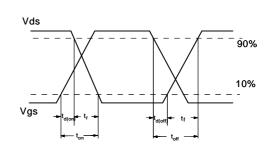
Gate Charge Test Circuit & Waveform



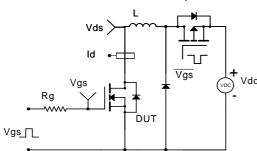


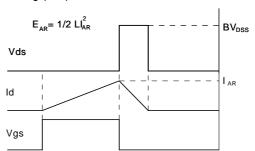
Resistive Switching Test Circuit & Waveforms



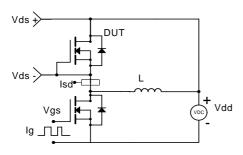


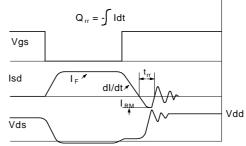
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms





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